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ROUND TYPE LED LAMPS

LG2041

DATA SHEET

DOC. NO : QW0905-LG2041

REV. : A

DATE : 07 - Mar.- 2005



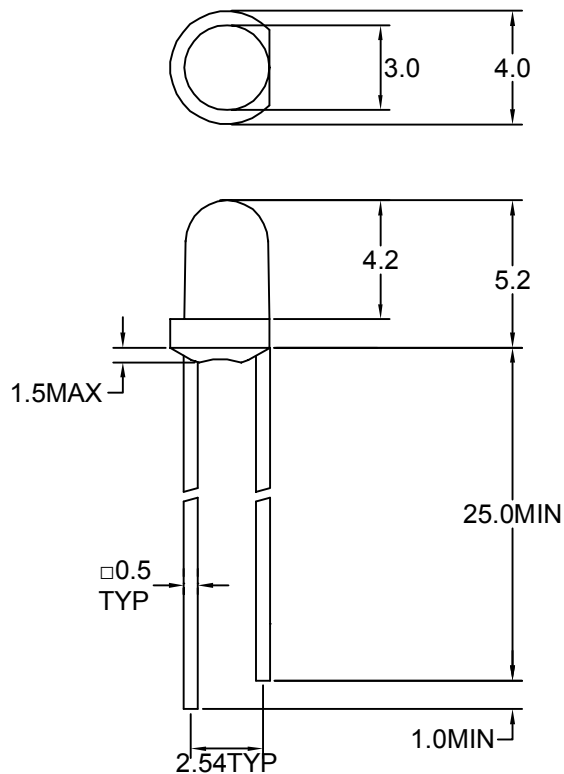
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PART NO. LG2041

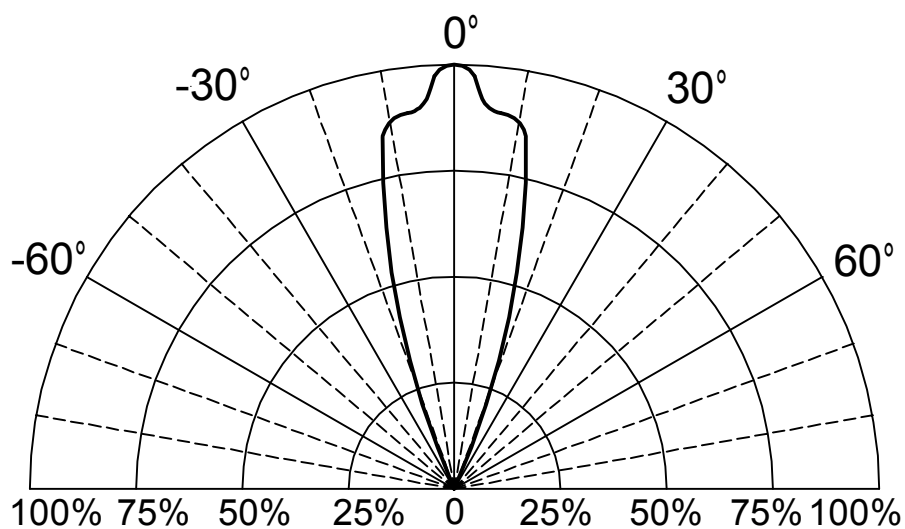
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Package Dimensions



Note : 1.All dimension are in millimeter tolerance is $\pm 0.25\text{mm}$ unless otherwise noted.
2.Specifications are subject to change without notice.

Directivity Radiation





Absolute Maximum Ratings at Ta=25

| Parameter | Symbol | Ratings | UNIT |
|---|------------------|--|------|
| | | G | |
| Forward Current | I _F | 30 | mA |
| Peak Forward Current Duty 1/10@10KHz | I _{FP} | 120 | mA |
| Power Dissipation | PD | 100 | mW |
| Reverse Current @5V | I _r | 10 | μA |
| Operating Temperature | T _{opr} | -40 ~ +85 | |
| Storage Temperature | T _{stg} | -40 ~ +100 | |
| Soldering Temperature | T _{sol} | Max 260 for 5 sec Max (2mm from body) | |

Typical Electrical & Optical Characteristics (Ta=25)

| PART NO | MATERIAL | COLOR | | Peak wave length Pnm | Spectral halfwidth nm | Forward voltage @20mA(V) | | Luminous intensity @10mA(mcd) | | Viewing angle 2 1/2 (deg) |
|---------|----------|---------|-------------------|-------------------------|--------------------------|-----------------------------|------|----------------------------------|------|------------------------------|
| | | Emitted | Lens | | | Min. | Max. | Min. | Typ. | |
| LG2041 | GaP | Green | Green Transparent | 565 | 30 | 1.7 | 2.6 | 30 | 45 | 30 |

Note : 1.The forward voltage data did not including ±0.1V testing tolerance.
2. The luminous intensity data did not including ±15% testing tolerance.



Typical Electro-Optical Characteristics Curve

G CHIP

Fig.1 Forward current vs. Forward Voltage

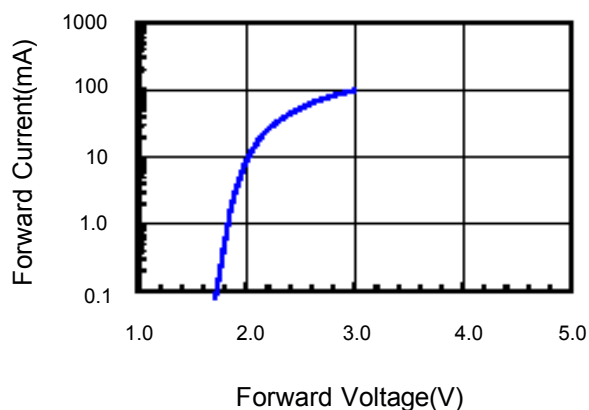


Fig.2 Relative Intensity vs. Forward Current

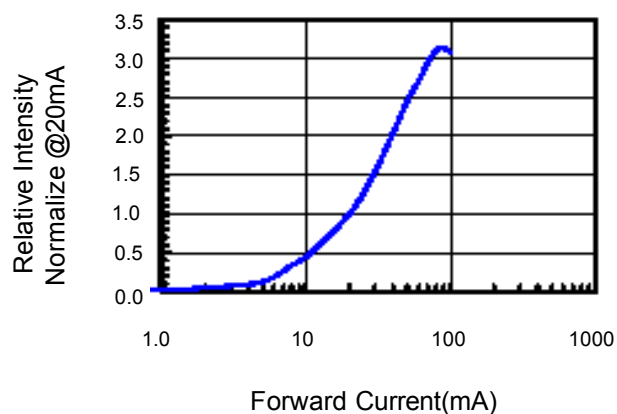


Fig.3 Forward Voltage vs. Temperature

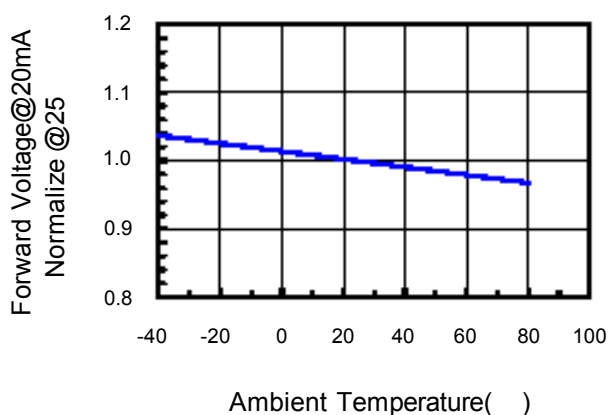


Fig.4 Relative Intensity vs. Temperature

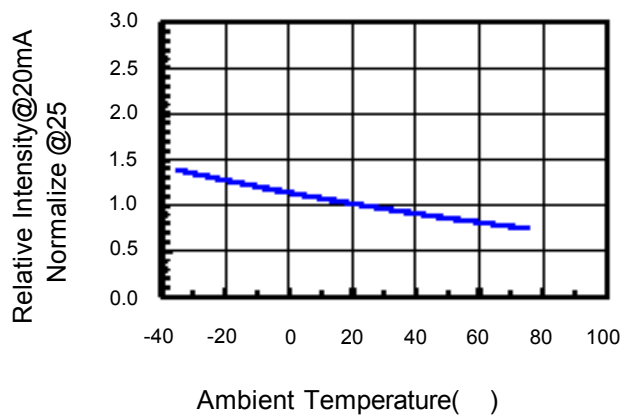
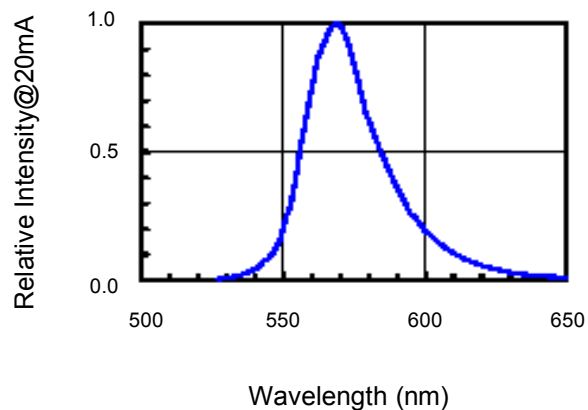


Fig.5 Relative Intensity vs. Wavelength



**Reliability Test:**

| Test Item | Test Condition | Description | Reference Standard |
|-------------------------------------|--|---|--|
| Operating Life Test | 1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs) | This test is conducted for the purpose of determining the resistance of a part in electrical and thermal stressed. | MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1 |
| High Temperature Storage Test | 1.Ta=105 ±5 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of high temperature for hours. | MIL-STD-883:1008 JIS C 7021: B-10 |
| Low Temperature Storage Test | 1.Ta=-40 ±5 2.t=1000 hrs (-24hrs, +72hrs) | The purpose of this is the resistance of the device which is laid under condition of low temperature for hours. | JIS C 7021: B-12 |
| High Temperature High Humidity Test | 1.Ta=65 ±5 2.RH=90 %~95 % 3.t=240hrs ±2hrs | The purpose of this test is the resistance of the device under tropical for hours. | MIL-STD-202:103B JIS C 7021: B-11 |
| Thermal Shock Test | 1.Ta=105 ±5 & -40 ±5 (10min) (10min) 2.total 10 cycles | The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature. | MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011 |
| Solder Resistance Test | 1.T.Sol=260 ±5 2.Dwell time= 10 ±1sec. | This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire. | MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1 |
| Solderability Test | 1.T.Sol=230 ±5 2.Dwell time=5 ±1sec | This test intended to see soldering well performed or not. | MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2 |